

ELECTRICAL DESIGN OF ADVANCED PACKAGING AND SYSTEMS (EDAPS)

4th Asian Workshop

12 and 13 December (Monday and Tuesday) 2005, Bangalore, India

Windsor Manor Sheraton & Towers, 25 Sankey Road, Bangalore 560052

Objective

The EDAPS Workshop is to enhance the technical awareness in the Asia region specifically in area of package and system electrical design concepts, issues and challenges ahead for next generation electronic products.

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